# Product / Package Information

<table>
<thead>
<tr>
<th>Package</th>
<th>TSSOP</th>
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<tbody>
<tr>
<td>Body Size</td>
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<tr>
<td>Lead Count</td>
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<tr>
<td>Terminal Finish</td>
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</tr>
<tr>
<td>MS Number</td>
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## Environmental Information

<table>
<thead>
<tr>
<th>Environmental Information</th>
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<tbody>
<tr>
<td>RoHS Compliant</td>
<td>Yes</td>
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<tr>
<td>High Temperature Compliant</td>
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</tr>
<tr>
<td>REACH SVHC Compliant</td>
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## Materials Declaration

### Molding Compound

<table>
<thead>
<tr>
<th>Description</th>
<th>Substance</th>
<th>CAS#</th>
<th>Homogeneous Material Level</th>
<th>Component Level</th>
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<tbody>
<tr>
<td>Weight (g)</td>
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<td>PPM</td>
<td>Percentage (%)</td>
<td>PPM</td>
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<td>1.78 E-03</td>
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<td>Phenol Resin</td>
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### Leadframe

<table>
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<tr>
<th>Description</th>
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<tbody>
<tr>
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<td>Percentage (%)</td>
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### Internal Leadframe Plating

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<th>Description</th>
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### External Leadframe Plating

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<td>Percentage (%)</td>
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### Bond Wires

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<td>Percentage (%)</td>
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<td>3.11 E-04</td>
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### Chip

<table>
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<tr>
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### Die Attach

<table>
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<tr>
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### Package Totals

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**Note:** The information provided in this declaration are true to the best of ADI’s knowledge. ADI derived most of the information listed in this declaration from documents provided by third parties, and assumes no liability to any inaccuracy of such information.
**Product / Package Information**

- **Package**: TSSOP
- **Body Size**: 4.4 mm
- **Lead Count**: 14
- **Terminal Finish**: SnPb
- **MS Number**: MS010657B

**Environmental Information**

- **RoHS Compliant**: No
- **High Temperature Compliant**: No
- **Halogen Free Compliant**: No
- **REACH SVHC Compliant**: Yes

### Molding Compound

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<tr>
<th>Description</th>
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### Leadframe

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### Bond Wires

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<tr>
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<tr>
<td>Precious metals</td>
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<td>3.11 E-04</td>
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### Chip

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<tr>
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<td>Percentage (%)</td>
<td>PPM</td>
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<tr>
<td>Other Inorganic Materials</td>
<td>Doped Silicon</td>
<td>7440-21-3</td>
<td>3.11 E-03</td>
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### Die Attach

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</tbody>
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### Package Totals

- **Weight (g)**: 5.69 E-02
- **Percentage (%)**: 100.0
- **PPM**: 1000000

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